Epoxy Flooring System for – ESD-Controlled Cleanroom Environments

By Ressichem Private Limited

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Why Epoxy Floorings at **ESD-Controlled Cleanroom Environments**

Cleanroom environments demand **extremely precise electrostatic discharge (ESD) control** to protect sensitive equipment, maintain contamination-free conditions, and ensure uninterrupted performance of precision operations. Even a minor electrostatic imbalance can result in **component failure, data corruption, or product rejection**.

The **Epoxy Flooring System for ESD-Controlled Cleanroom Environments** by **Ressichem** provides a **highly conductive, seamless, and durable epoxy floor system** specifically engineered for cleanroom-grade environments. It ensures **controlled and uniform static dissipation**, in coordination with grounding networks, while maintaining a smooth, hygienic, and low-particle-emitting surface.

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This system is suitable for

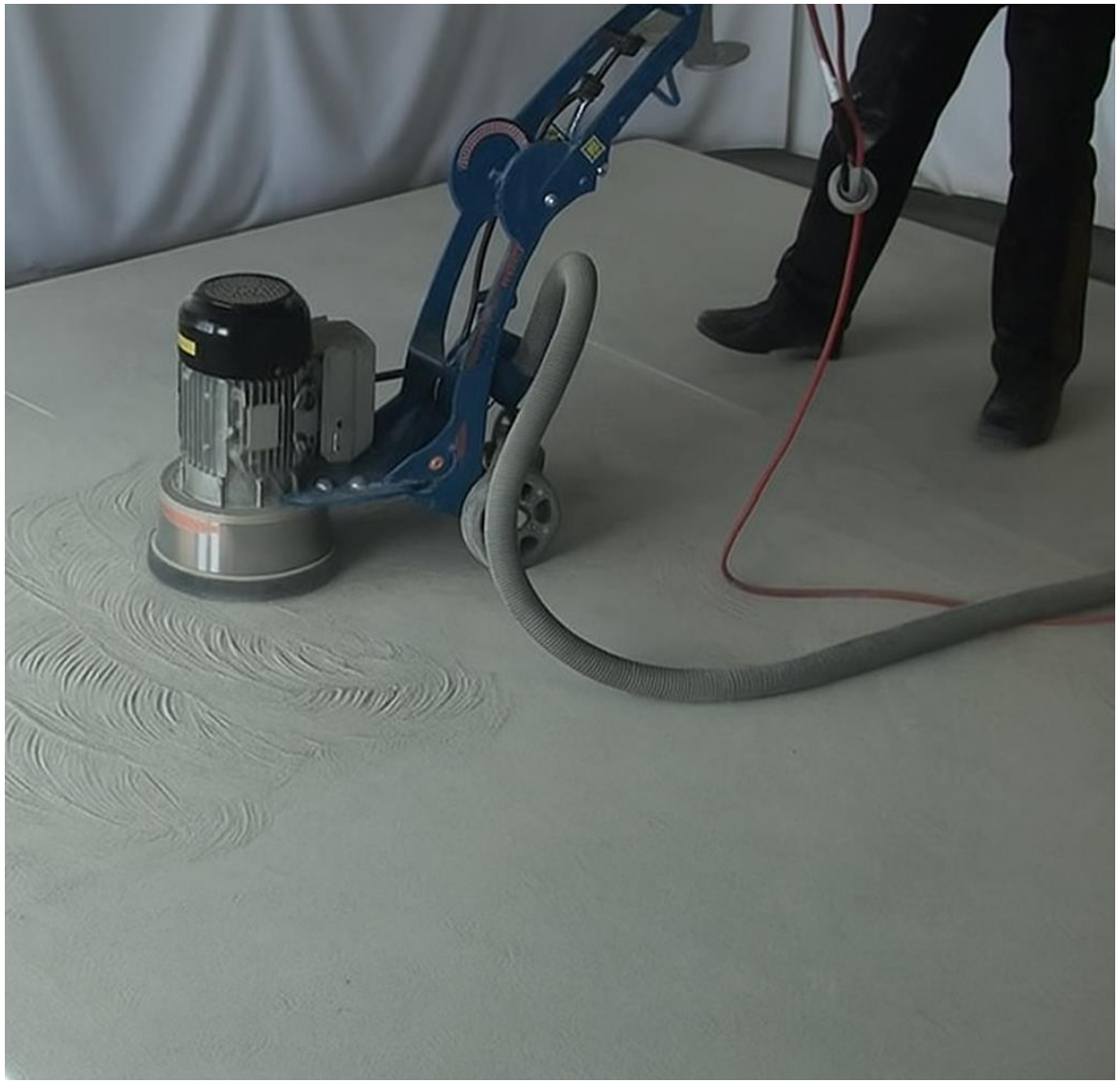
- Semiconductor and microchip manufacturing
- Pharmaceutical cleanrooms
- Medical device production facilities
- Precision laboratories and calibration zones
- Aerospace and defense electronics assembly
- Research & development centers with controlled ESD requirements

Step 1: Surface Preparation (1 of 2)

Proper substrate evaluation and preparation are critical to ensure uniform grounding and long-term ESD performance.

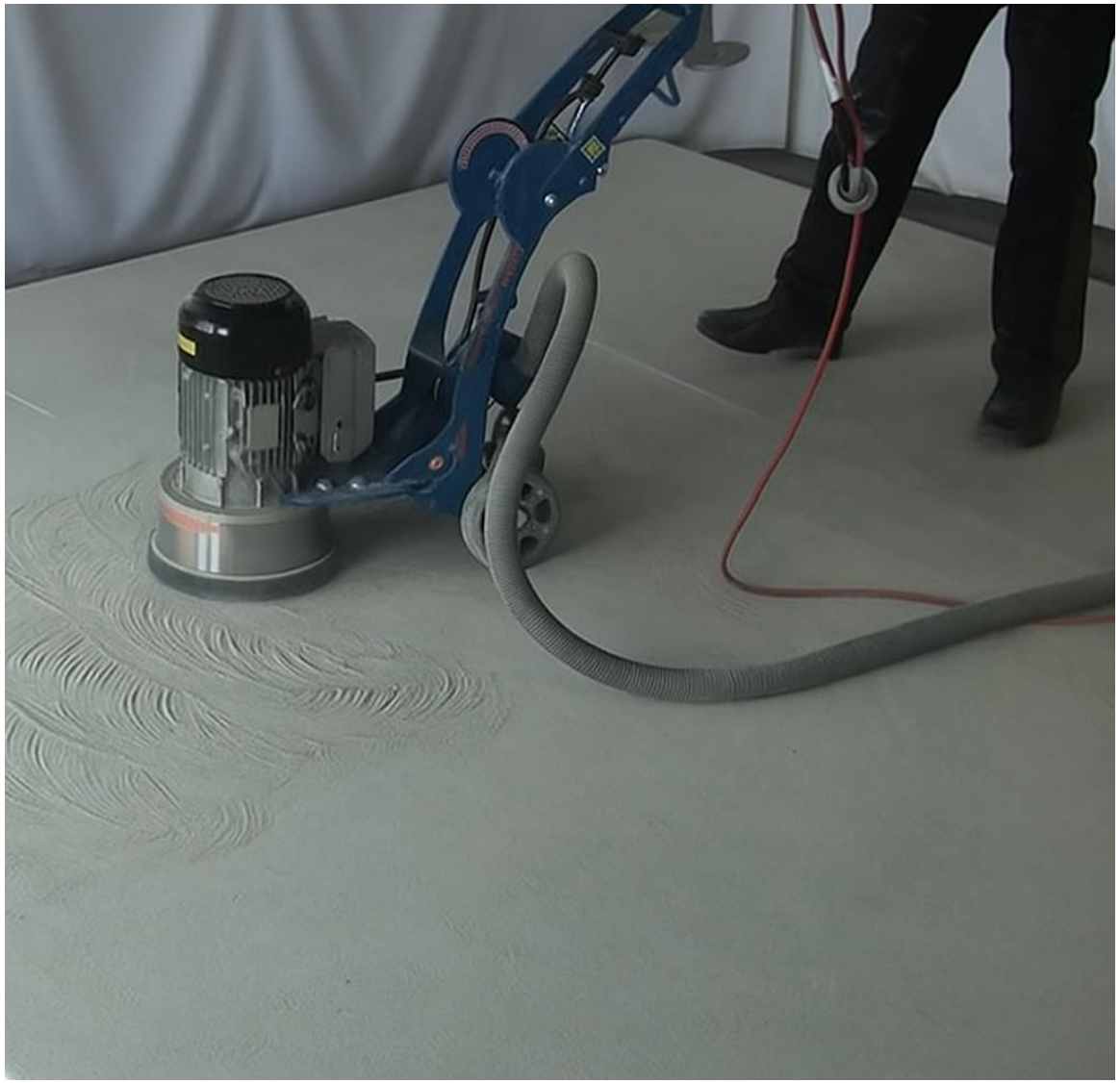
All necessary surface repairs, including crack filling or substrate restoration, must be completed prior to the application of any epoxy flooring materials.

- The **concrete strength** requirement must be defined by the project consultant as per the operational load profile.
- Perform both **destructive (core sample)** and **non-destructive (Schmidt Hammer)** strength testing to verify substrate integrity.



Step 1: Surface Preparation (2 of 2)

- For **major repairs (≥ 12 mm)**, apply **Ressi NSG 710**, a high-strength, non-shrink cementitious repair mortar.
- For **minor imperfections**, use **Ressi EPO Primer LV** blended with **Ressichem's washed, graded, and completely dried silica sand** to form a moisture-free repair paste.
- Mechanically prepare the substrate through **shot blasting or diamond grinding** to ensure an oil-free, dust-free surface.
- In previously used floors, ensure full removal of oil or grease contamination before application.



Step 2: Application of Ressi SLS Primer – 1 and Ressi SLS 610 (If Required)

If leveling is required to achieve a uniform substrate before epoxy application, apply **Ressi SLS Primer – 1** followed by **Ressi SLS 610**, a **self-leveling cementitious floor screed**.

Allow **7–14 days** for the screed to release moisture depending on ambient temperature and humidity before proceeding with epoxy installation. Ensure **moisture level < 5%** before further coating.

Step 3: Application of Ressi EPO Primer LV and Copper Strip Installation

Apply **Ressi EPO Primer LV**, a **low-viscosity, solvent-free epoxy primer** that promotes bonding and surface sealing. During this stage, the **copper grounding network** is integrated into the flooring system.

- Copper strips are **bonded using Ressi EPO Primer LV** over the prepared surface.
- The **spacing, width, and thickness** of the copper strips are to be determined according to the client's ESD requirement.
- Once installed, the **continuity and discharge capacity** of the grounding system should be tested and verified before applying the conductive topcoat.
- This ensures that the entire copper grid forms a consistent and functional discharge path across the floor area.

Step 4: Application of Ressi EPO Anti-Static

Apply **Ressi EPO Anti-Static**, a **conductive epoxy topcoat** that ensures seamless conductivity across the surface and effective connection to the copper grounding system.

- Apply the material at a **minimum thickness of 1000 microns above the height of the copper strip layout**.
    - For example: if the copper strip thickness is **1000 microns**, the total topcoat thickness should be **2000 microns**, ensuring the conductive layer adequately covers and protects the strips.
- Apply using a **notched trowel or epoxy squeegee**, followed by **back rolling** to achieve a uniform finish.
- Allow the coating to **fully cure** before conducting ESD validation.

System Summary Table

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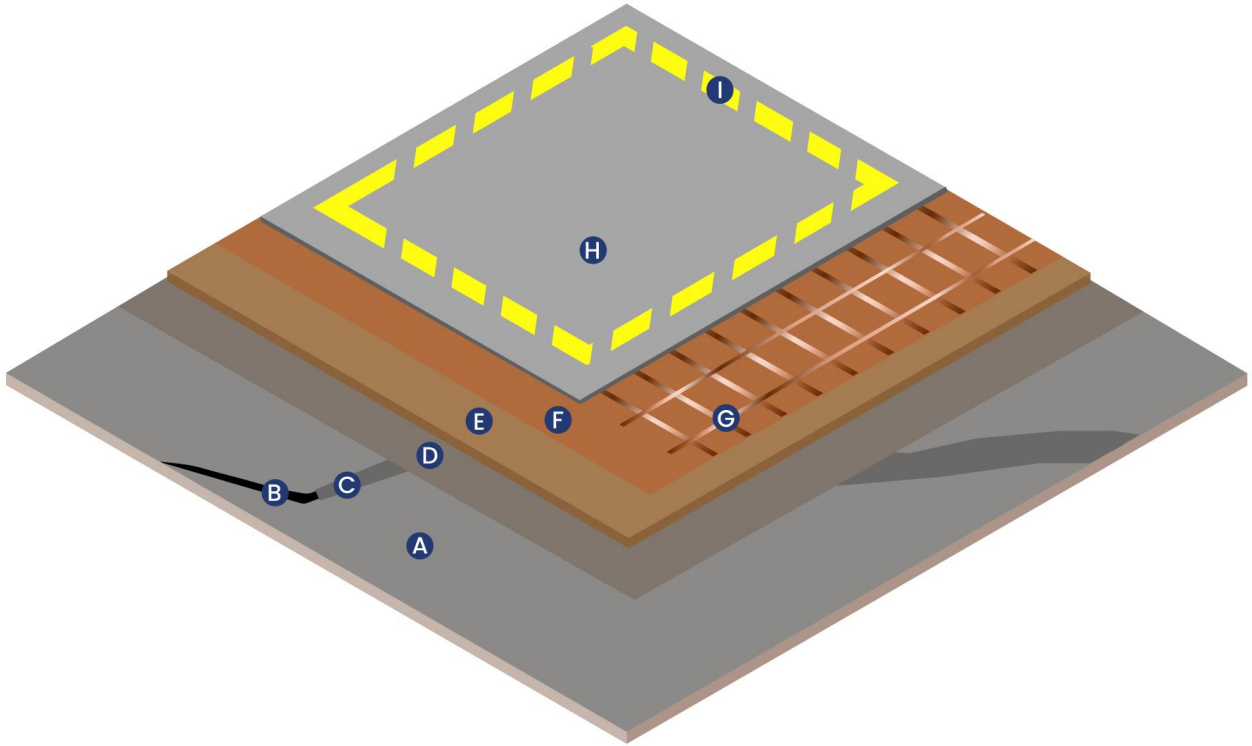
Parameter	Description
System Name	Epoxy Flooring System for – ESD-Controlled Cleanroom Environments
Area Type	Specialized / High-Performance – Cleanroom & ESD-Controlled Facilities
Traffic Exposure	Light to Heavy (as per cleanroom equipment)
Primary Requirement	Controlled ESD Discharge and Grounding Integration
Primer (Optional)	Ressi SLS Primer – 1 (for SLS systems)
Leveling Layer (Optional)	Ressi SLS 610 (if required)
Epoxy Primer	Ressi EPO Primer LV (used for both priming and copper bonding)
Conductive Layer	Ressi EPO Anti-Static (≥ 1000 microns above copper layout)
Silica Used	Washed, graded, and completely dried (zero-moisture) silica sand
Copper Grid Network	Installed and grounded as per site-specific ESD requirements
Application Method	High-Build Trowel or Epoxy Squeegee
Finish Type	Smooth, Low-Gloss / Semi-Gloss Conductive Finish
Curing Time Before Use	48–72 Hours (Light Access) / 7 Days (Full Cure)
Key Benefits	ESD Control, Durability, GMP Hygiene, Grounding Integration

System Summary Diagram

A) Cementitious Surface: (Concrete slab or screed)
B) Cracks and surface damage
C) Crack Filler and Repairing Materials
D) Ressi SLS Primer – 1
E) Ressi SLS 610
F) Ressi EPO Primer LV
G) Copper Strips
H) Ressi EPO Anti-Static
I) Ressi EPO Anti-Static (Marking)



Thank You

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